

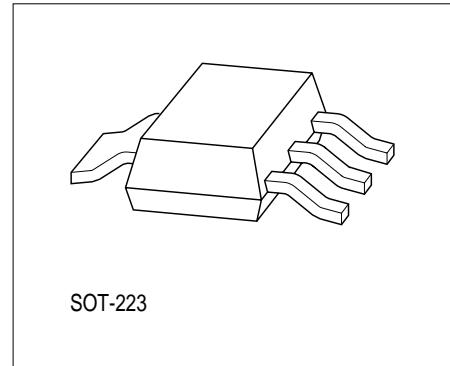
5 V/10 V Low-Drop Voltage Regulator

TLE 4266

Bipolar IC

Features

- Output voltage 5 V or 10 V
- Output voltage tolerance $\leq \pm 2\%$
- 120 mA current capability
- Very low current consumption
- Low-drop voltage
- Overtemperature protection
- Reverse polarity proof
- Wide temperature range
- Suitable for use in automotive electronics
- Inhibit



Type	Ordering Code	Package
TLE 4266 G	Q67006-A9152	P-SOT223-4-2 (SMD)
TLE 4266 GSV10	Q67006-A9355	P-SOT223-4-2 (SMD)



▼ New type

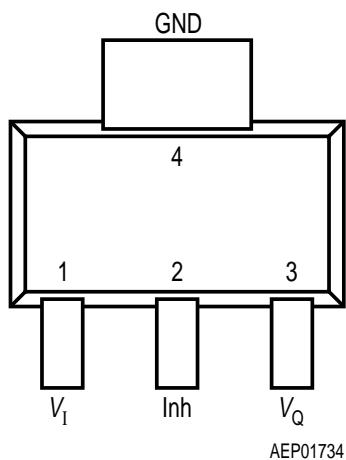
Functional Description

TLE 4266 G is a low-drop voltage regulator for 5 V or 10 V supply in a P-SOT223-4-2 SMD package. The IC regulates an input voltage V_i in the range of 5.5 V / $10.5 V < V_i < 45 V$ to $V_{Q_{rated}} = 5 V/10 V$. The maximum output current is more than 120 mA. The IC can be switched off via the inhibit input, which causes the current consumption to drop below 10 μA . The IC is shortcircuit-proof and incorporates temperature protection that disables the IC at overtemperature.

Dimensioning Information on External Components

The input capacitor C_i is necessary for compensating line influences. Using a resistor of approx. 1 Ω in series with C_i , the oscillating of input inductivity and input capacitance can be clamped. The output capacitor C_Q is necessary for the stability of the regulating circuit. Stability is guaranteed at values $C_Q \geq 10 \mu F$ and an ESR $\leq 10 \Omega$ within the operating temperature range.

Pin Configuration (top view)



Pin Definitions and Functions

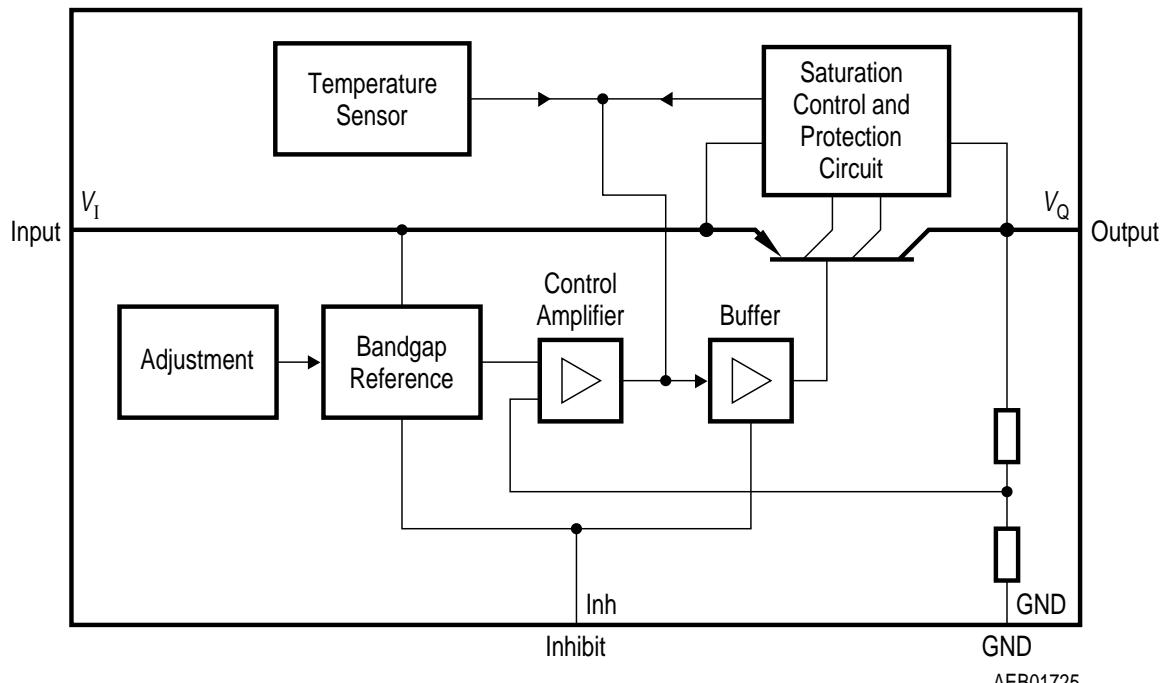
Pin	Symbol	Function
1	V_I	Input voltage ; block to ground directly at the IC with a ceramic capacitor.
2	Inh	Inhibit ; low-active input.
3	V_Q	Output voltage ; block to ground with a capacitor. $C \geq 10 \mu\text{F}$.
4	GND	Ground

Circuit Description

The device produces a precise reference voltage, that is very accurate due to resistor adjustment. A control amplifier compares the divided output voltage to this reference voltage and drives the base of the PNP series transistor through a buffer.

Saturation control as a function of the load current prevents any oversaturation of the power element. The IC also incorporates a number of protection circuitry for:

- Overload
- Overtemperature
- Reverse polarity



Block Diagram

Absolute Maximum Ratings (TLE 4266 G, TLE 4266 GSV10)
 $T_j = -40 \text{ to } 150 \text{ }^\circ\text{C}$

Parameter	Symbol	Limit Values		Unit	Notes
		min.	max.		

Input

Voltage	V_i	- 42	45	V	-
Current	I_i	-	-	-	internally limited

Inhibit

Voltage	V_{INH}	- 42	45	V	-
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Output

Voltage	V_Q	- 1	16	V	-
Current	I_Q	-	-	-	internally limited

GND

Current	I_M	50	-	mA	-
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Temperature

Junction temperature	T_j	-	150	$^\circ\text{C}$	-
Storage temperature	T_s	- 50	150	$^\circ\text{C}$	-

Operating Range (TLE 4266 G)

Input voltage	V_i	5.5	45	V	-
Junction temperature	T_j	- 40	150	$^\circ\text{C}$	-

Operating Range (TLE 4266 GSV10)

Input voltage	V_i	10.5	45	V	-
Junction temperature	T_j	- 40	150	$^\circ\text{C}$	-

Thermal Resistance

Junction ambient	R_{thjA}	-	100	K/W	soldered
Junction case	R_{thjc}	-	25	K/W	-

Characteristics (TLE 4266 G)
 $V_i = 13.5 \text{ V}; -40^\circ\text{C} \leq T_j \leq 125^\circ\text{C}$

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Output voltage	V_Q	4.9	5	5.1	V	$5 \text{ mA} \leq I_Q \leq 100 \text{ mA}$ $6 \text{ V} \leq V_i \leq 28 \text{ V}$
Output-current limitation	I_Q	120	150	—	mA	—
Current consumption $I_q = I_i - I_Q$	I_q	—	0	10	μA	$V_{INH} = 0 \text{ V}; T_j \leq 100^\circ\text{C}$
Current consumption $I_q = I_i - I_Q$	I_q	—	—	400	μA	$I_Q = 1 \text{ mA}$ Inhibit ON
Current consumption $I_q = I_i - I_Q$	I_q	—	10	15	mA	$I_Q = 100 \text{ mA}$ Inhibit ON
Drop voltage	V_{Dr}	—	0.25	0.5	V	$I_Q = 100 \text{ mA}^1)$
Load regulation	ΔV_Q	—	—	40	mV	$I_Q = 5 \text{ to } 100 \text{ mA}$ $V_i = 6 \text{ V}$
Supply-voltage regulation	ΔV_Q	—	15	30	mV	$V_i = 6 \text{ V to } 28 \text{ V}$ $I_Q = 5 \text{ mA}$
Supply-voltage rejection	SVR	—	54	—	dB	$f_r = 100 \text{ Hz}, V_r = 0.5 V_{SS}$

Inhibit

Inhibit on voltage	$V_{INH, on}$	3.5	—	—	V	—
Inhibit off voltage	$V_{INH, off}$	—	—	—0.8	V	—
Inhibit current	I_{INH}	5	15	25	μA	$V_e = 5 \text{ V}$

1) Drop voltage = $V_i - V_Q$ (measured when the output voltage V_Q has dropped 100 mV from the nominal value obtained at $V_i = 13.5 \text{ V}$).

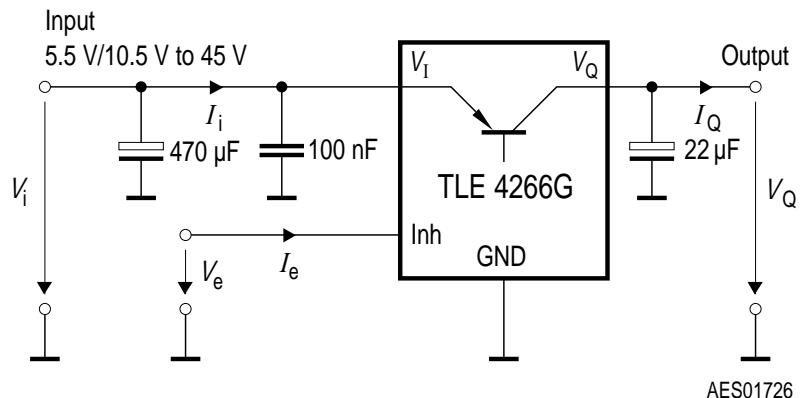
Characteristics (TLE 4266 GSV10)
 $V_i = 13.5 \text{ V}; -40^\circ\text{C} \leq T_j \leq 125^\circ\text{C}$

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Output voltage	V_Q	9.8	10	10.2	V	$5 \text{ mA} \leq I_Q \leq 100 \text{ mA}$ $11 \text{ V} \leq V_i \leq 21 \text{ V}$
Output voltage	V_Q	9.8	10	10.2	V	$1 \text{ mA} \leq I_Q \leq 50 \text{ mA}$ $11 \text{ V} \leq V_i \leq 28 \text{ V}$
Output-current limitation	I_Q	120	150	—	mA	—
Current consumption $I_q = I_i - I_Q$	I_q	—	0	10	μA	$V_{INH} = 0 \text{ V}; T_j \leq 100^\circ\text{C}$
Current consumption $I_q = I_i - I_Q$	I_q	—	350	500	μA	$I_Q = 1 \text{ mA}$ Inhibit ON
Current consumption $I_q = I_i - I_Q$	I_q	—	7	15	mA	$I_Q = 100 \text{ mA}$ Inhibit ON
Drop voltage	V_{Dr}	—	0.28	0.5	V	$I_Q = 100 \text{ mA}^1)$
Load regulation	ΔV_Q	—40	—20	40	mV	$I_Q = 5 \text{ to } 50 \text{ mA}$ $V_i = 11 \text{ V}$
Supply-voltage regulation	ΔV_Q	—30	5	30	mV	$V_i = 11 \text{ V to } 28 \text{ V}$ $I_Q = 5 \text{ mA}$
Supply-voltage rejection	SVR	—	54	—	dB	$f_r = 100 \text{ Hz}, V_r = 0.5 V_{SS}$

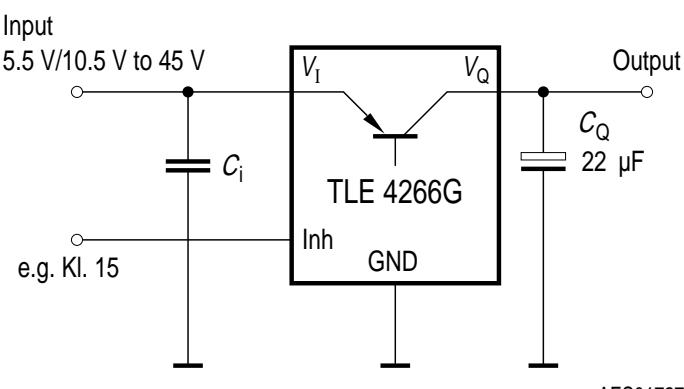
Inhibit

Inhibit on voltage	$V_{INH, on}$	3.5	—	—	V	—
Inhibit off voltage	$V_{INH, off}$	—	—	—0.8	V	—
Inhibit current	I_{INH}	5	15	25	μA	$V_{INH} = 5 \text{ V}$

1) Drop voltage = $V_i - V_Q$ (measured when the output voltage V_Q has dropped 100 mV from the nominal value obtained at $V_i = 13.5 \text{ V}$).

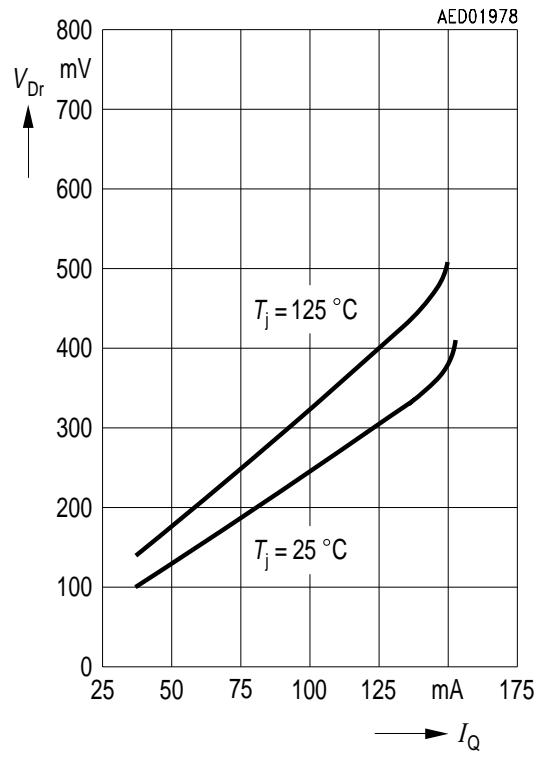


Measuring Circuit (TLE 4266 G, TLE 4266 GSV10)

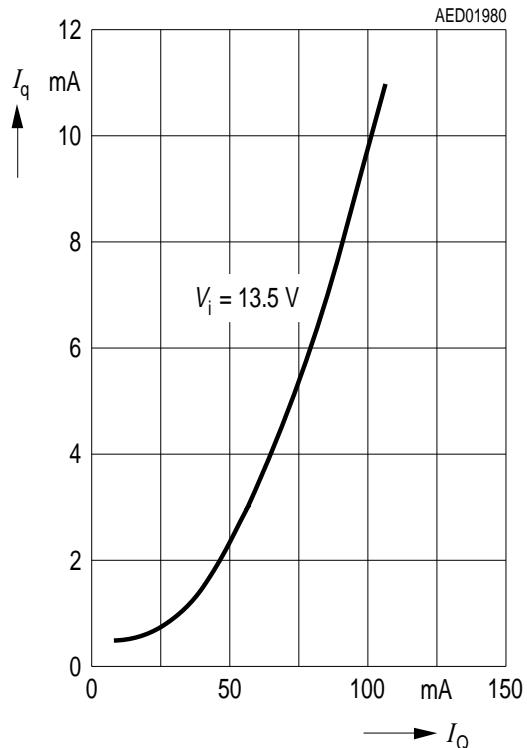


Application Circuit (TLE 4266 G, TLE 4266 GSV10)

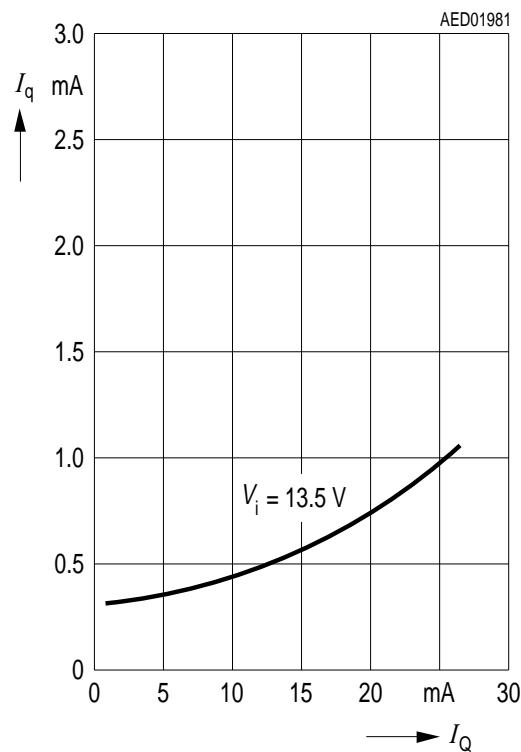
Drop Voltage V_{Dr} versus Output Current I_Q (5 V, 10 V)



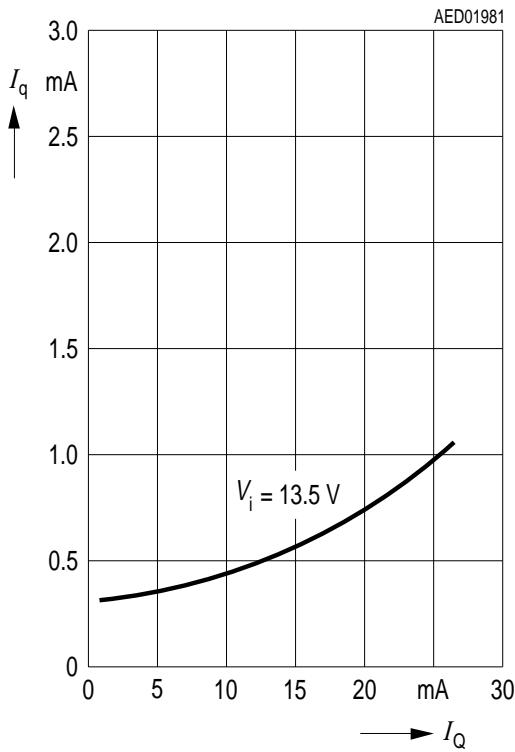
Current Consumption I_q versus Output Current I_Q (5 V, 10 V)

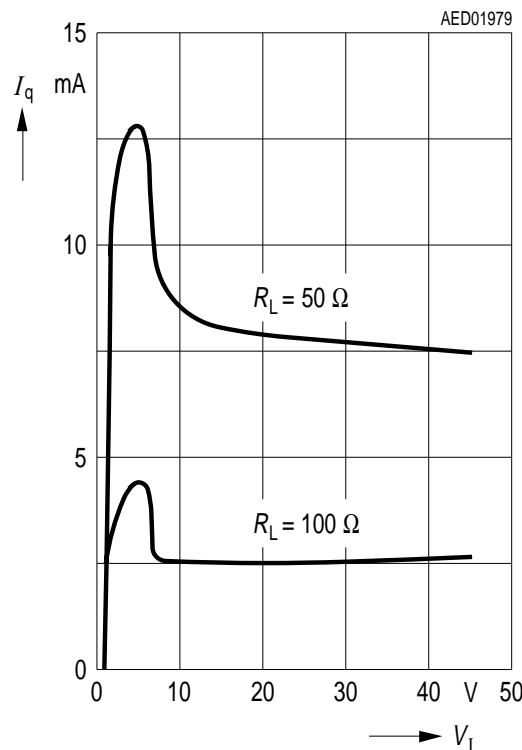
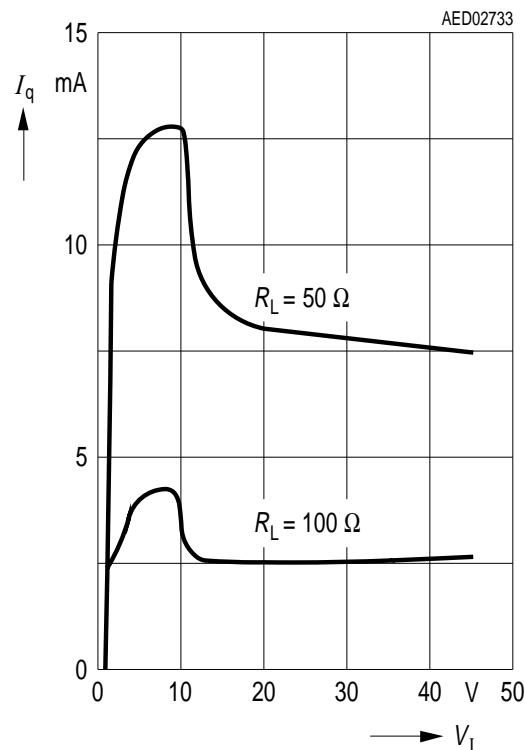
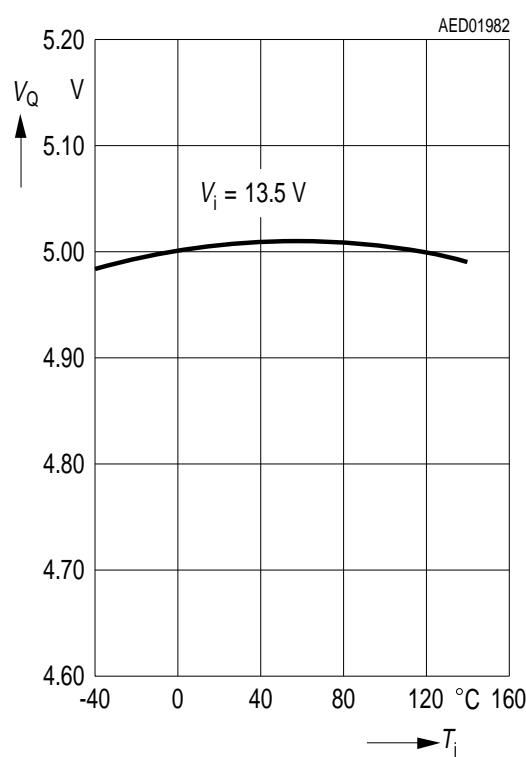
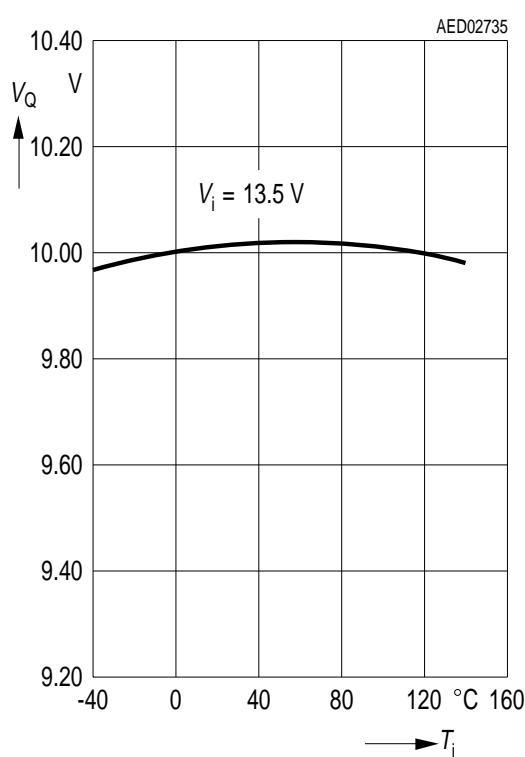


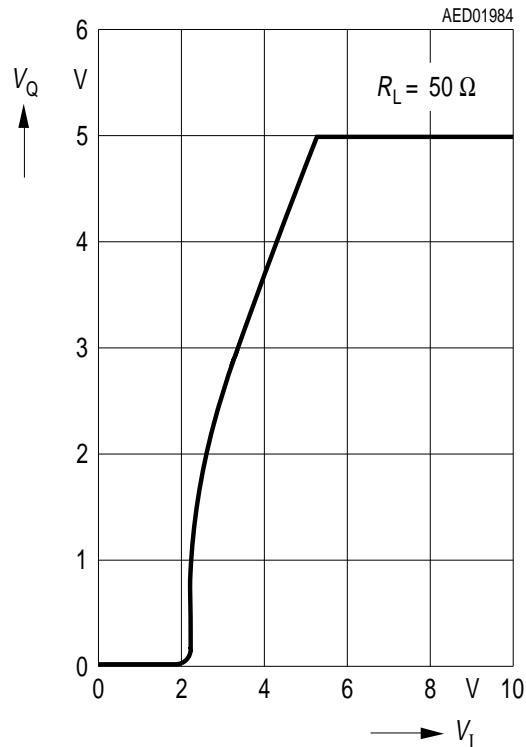
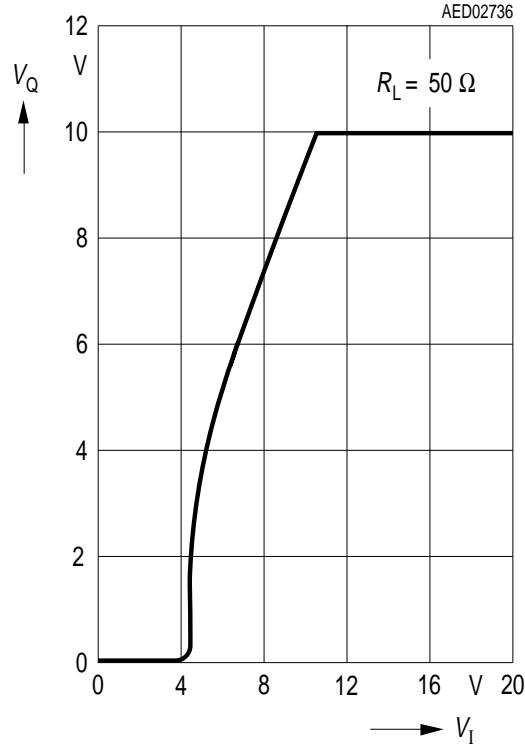
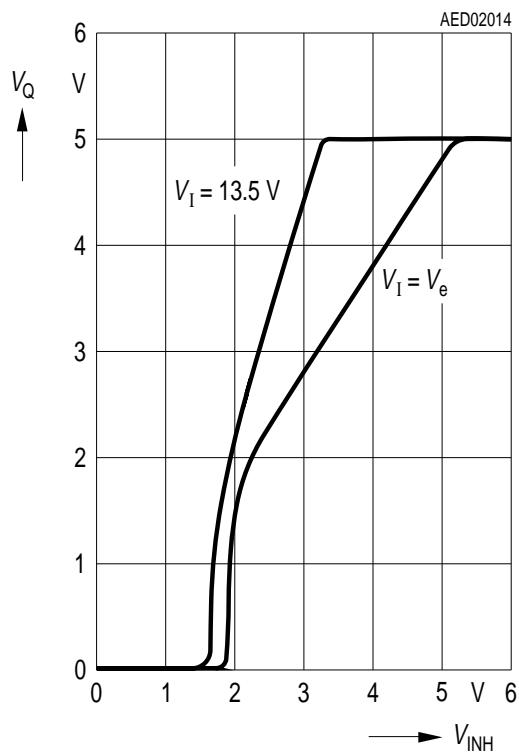
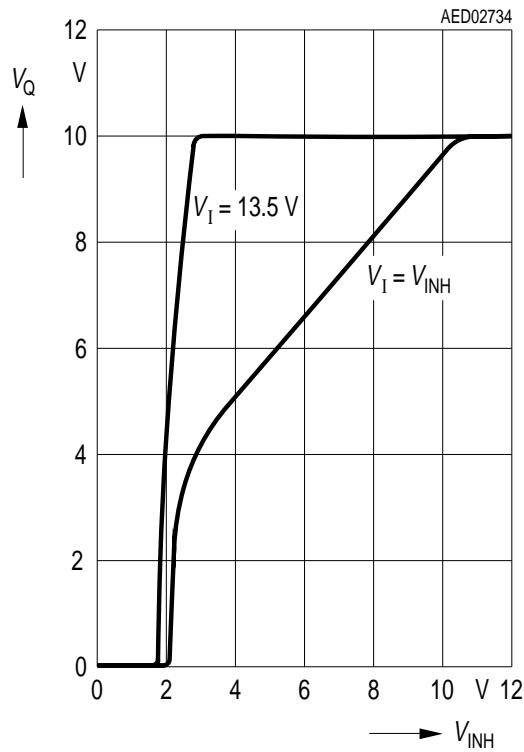
Current Consumption I_q versus Output Current I_Q (5 V version)



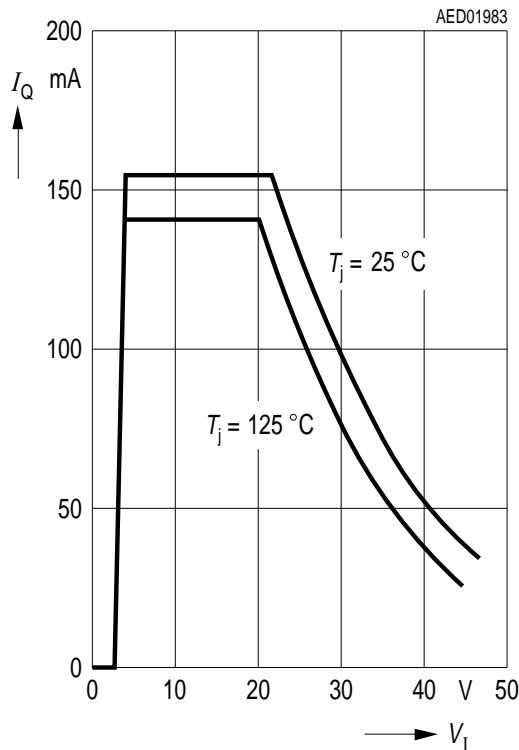
Current Consumption I_q versus Output Current I_Q (10 V version)



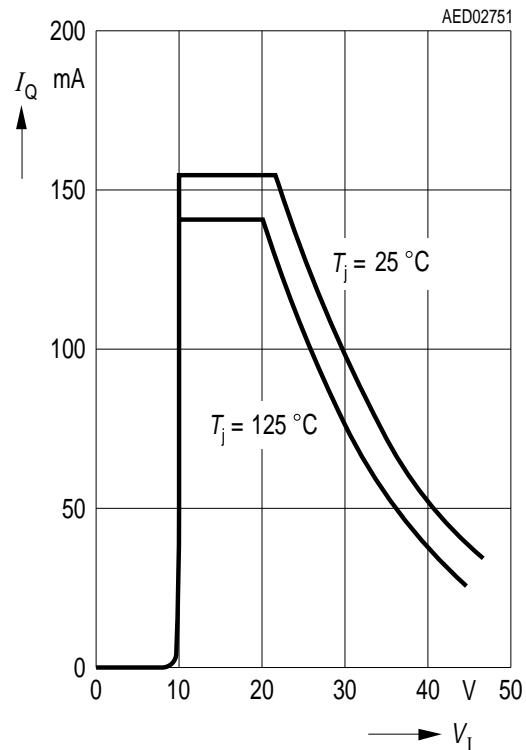
**Current Consumption I_q versus
Input Voltage V_i (5 V version)**

**Current Consumption I_q versus
Input Voltage V_i (10 V version)**

**Output Voltage V_Q versus
Temperature T_j (5 V version)**

**Output Voltage V_Q versus
Temperature T_j (10 V version)**


**Output Voltage V_Q versus
Input Voltage V_I (5 V version)**

**Output Voltage V_Q versus
Input Voltage V_I (10 V version)**

**Output Voltage V_Q versus
Inhibit Voltage V_{INH} (5 V version)**

**Output Voltage V_Q versus
Inhibit Voltage V_{INH} (10 V version)**


**Output Current I_Q versus
Input Voltage V_I (5 V-version)**



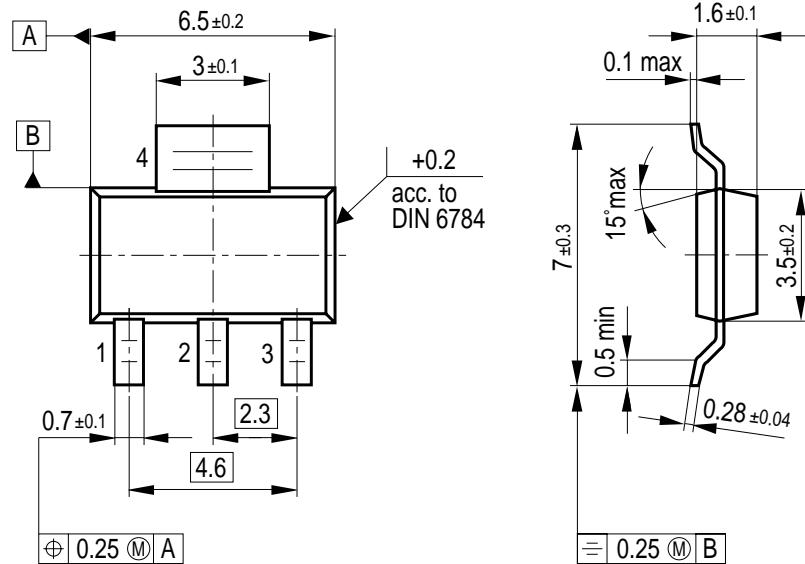
**Output Current I_Q versus
Input Voltage V_I (10 V version)**



Package Outlines

P-SOT223-4-2

(Plastic Small Outline Transistor)



Weight approx. 0.15 g

GPS05560

Sorts of Packing

Package outlines for tubes, trays etc. are contained in our Data Book "Package Information"

SMD = Surface Mounted Device

Dimensions in mm

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